

ITW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 5528**  
Etsuko NAKAMURA et al. : Docket No. 2003\_1698A  
Serial No. 10/721,164 : Group Art Unit 1752  
Filed November 26, 2003 : Examiner Amanda C. Walke



LOWER LAYER MATERIAL FOR WIRING,  
EMBEDDED MATERIAL, AND WIRING  
FORMATION METHOD

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**RESPONSE**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This is in response to the Official Action dated March 15, 2005.